

## Photo DMOS-FET Relay

### Description

The **LT710** is a miniature 2-Form A solid state relay in a 8 pin SMD package that employs optically coupled MOSFET technology to provide 3750V of input to output isolation. The optically coupled input is controlled by a highly efficient GaAlAs infrared LED and MOS FETs on the output side.

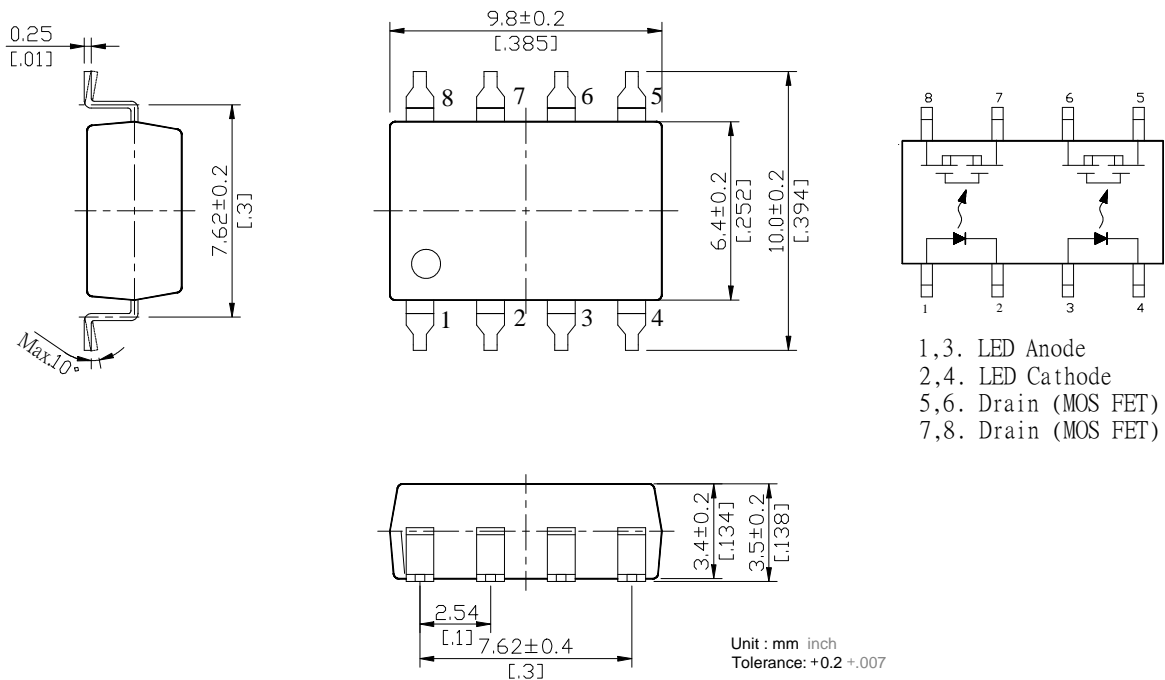
### Features

- Low driver power requirements (TTL/CMOS Compatible)
- High reliability
- Arc-Free with no snubbing circuits
- 3750Vrms Input/Output isolation
- Tape & Reel version available

### Applications

- Telecommunications (PC, Electronic notepad)
- Measuring and Testing equipment
- Industrial control
- Security equipments
- High speed inspection machine

### Outline Dimensions



## Photo DMOS-FET Relay Specifications

### Part Name: LT710

(Load voltage: 400V / Load current: 130mA)

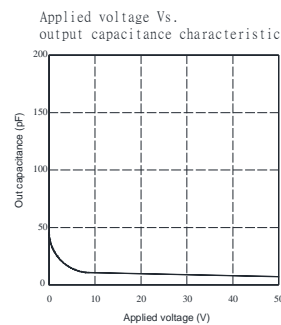
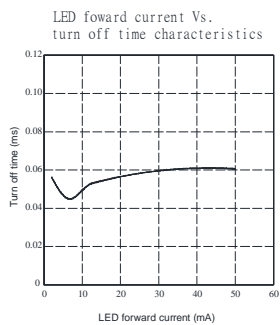
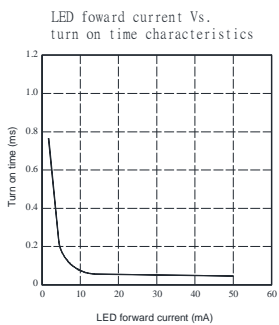
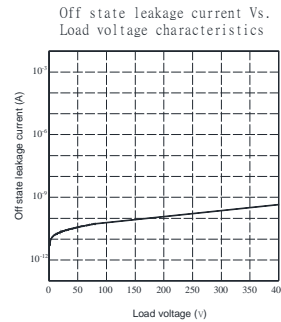
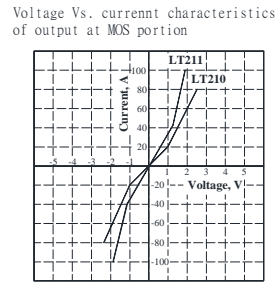
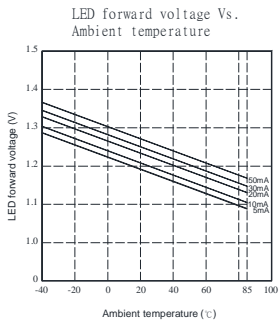
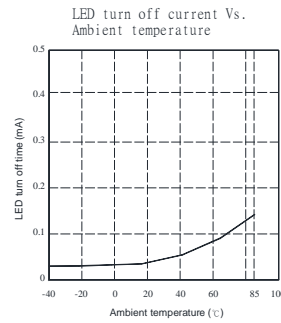
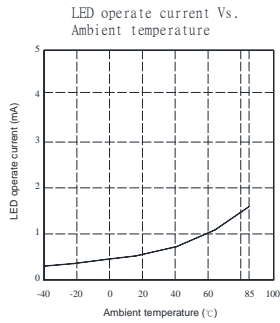
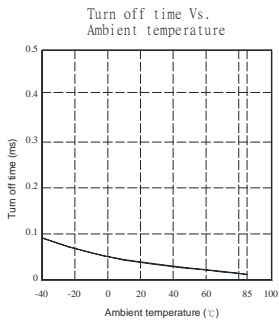
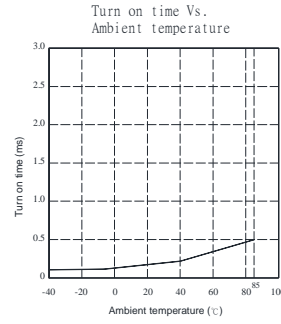
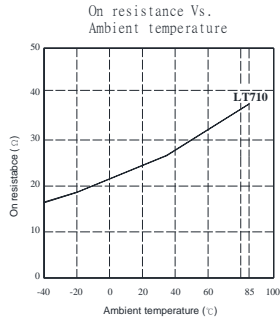
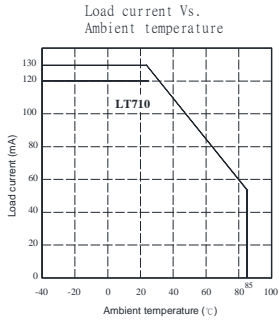
#### Absolute Maximum Ratings (Ambient Temperature: 25°C)

Item	Symbol	Value	Units	Note	
Input	Continuous LED Current	I <sub>F</sub>	50	mA	
	Peak LED Current	I <sub>FP</sub>	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V <sub>R</sub>	5	V	
	Input Power Dissipation	P <sub>In</sub>	75	mW	
Output	Load Voltage	V <sub>L</sub>	400	V(AC peak or DC)	
	Load Current	I <sub>L</sub>	130	mA	
	Peak Load Current	I <sub>Peak</sub>	0.6	A	100ms(1 pulse)
	Output Power Dissipation	P <sub>out</sub>	300	mW	
Total Power Dissipation	P <sub>T</sub>	350	mW		
I/O Breakdown Voltage	V <sub>I/O</sub>	3750	V <sub>rms</sub>	RH=60%, 1min	
Operating Temperature	T <sub>Opr</sub>	-40 to +85	°C		
Storage Temperature	T <sub>Stg</sub>	-40 to +100	°C		
Pin Soldering Temperature	T <sub>Sol</sub>	260	°C	10 sec max.	

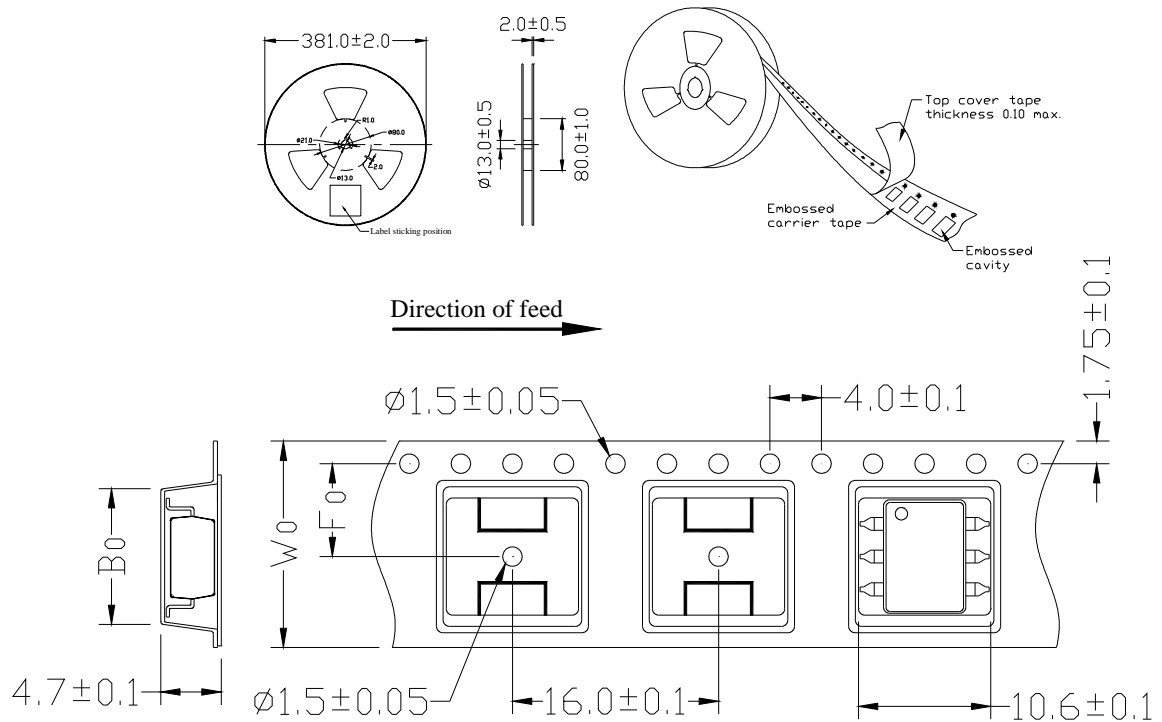
#### Electrical Specifications (Ambient Temperature: 25°C)

Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions	
Input	LED Forward Voltage	V <sub>F</sub>		1.2	1.4	V	I <sub>F</sub> =10mA
	Operation LED Current	I <sub>F On</sub>		0.5	3.0	mA	
	Recovery LED Current	I <sub>F Off</sub>		0.35	0.5	mA	
	Recovery LED Voltage	V <sub>F Off</sub>	0.5			V	
Output	On-Resistance	R <sub>On</sub>		20	30	Ω	I <sub>F</sub> =5mA, I <sub>L</sub> =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I <sub>Leak</sub>			1	uA	V <sub>L</sub> =Rating
	Output Capacitance	C <sub>Out</sub>		110		pF	V <sub>L</sub> =0, f=1MHz
Transmission	Turn-On Time	T <sub>On</sub>		0.23	0.5	ms	I <sub>F</sub> =5mA, I <sub>L</sub> =100mA,
	Turn-Off Time	T <sub>Off</sub>		0.03	0.2	ms	
Coupled	I/O Isolation Resistance	R <sub>I/O</sub>	10 <sup>10</sup>			Ω	DC500V
	I/O Capacitance	C <sub>I/O</sub>		0.8	1.5	pF	f=1MHz

## Reference Data



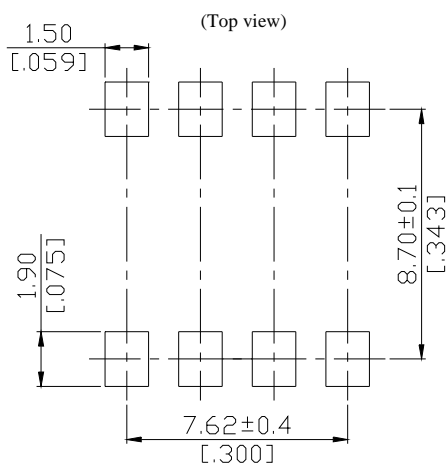
## Taping Specifications for Surface Mount Devices



Unit: mm

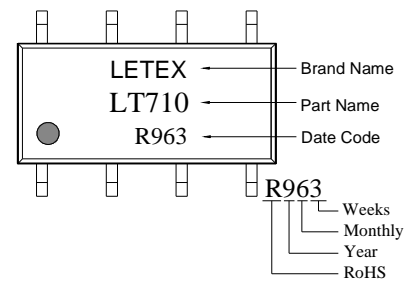
TYPE	B0±0.1	F0±0.1	W0±0.1	13"REEL/PCS
4P	5.3	7.5	16	1000
6P	9.4	7.5	16	1000
8P	10.3	11.5	24	1000

### Recommended Mounting Pad



### Marking

(Each photo MOS Relay shall be marked with the following information)



Unit : mm [inch]  
Tolerance : ±0.1

- Note: 1. There shall be leader of 230 mm minimum which may consist of carrier and or cover tape follower by a minimum of 160 mm of carrier tape sealed with cover tape.
2. There shall be a minimum of 160 mm of empty component pockets sealed with cover tape.
3. Devices are pockets in accordance with EIA standard EIA-481-A and specifications given above.